

## Product End-of-Life Disassembly Instructions

Marketing Name / Model [List multiple models if applicable.]	Product Category
HP ProLiant s6500 Chassis	Server

**Purpose:** The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment.

### 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	3
Batteries	All types including standard alkaline and lithium coin or button style batteries	0
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB / PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height	Depending on model number	2



External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0

## 2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Torx screw driver	T15
Flat head screw driver	Medium
Philips Screw Driver	#2

## 3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

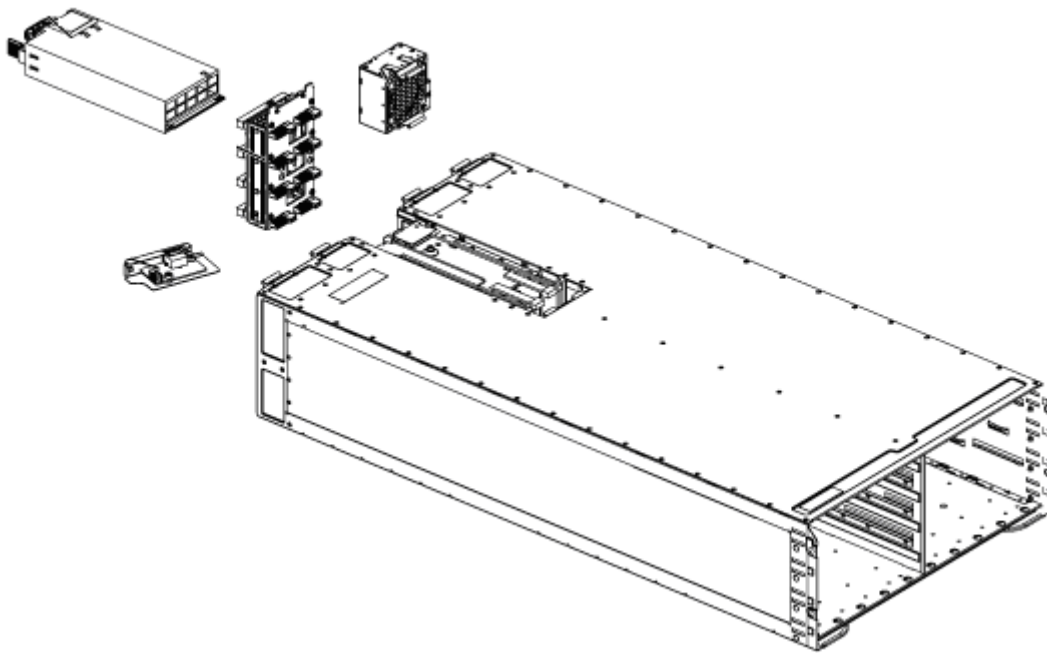
1. System Board Battery - Locate the battery on the system board. Use a medium flat head screwdriver or fingers to remove the battery and dispose of properly

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

Attachment 1 – Exploded view

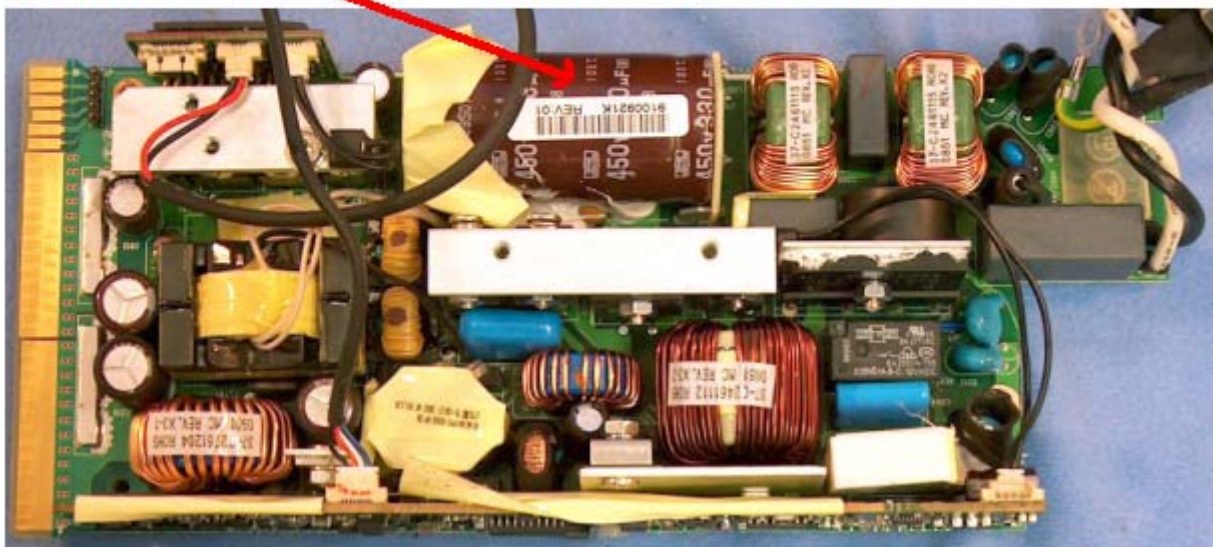
Attachment 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12 - Capacitor location by model number of supply



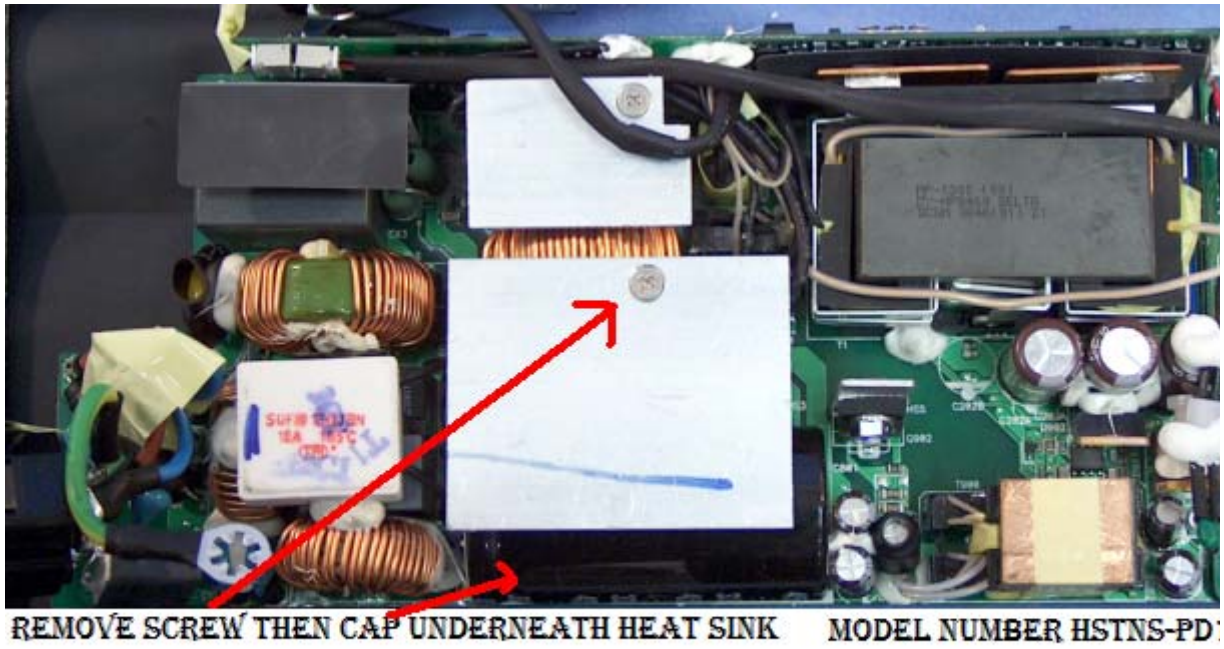


Attachment 1

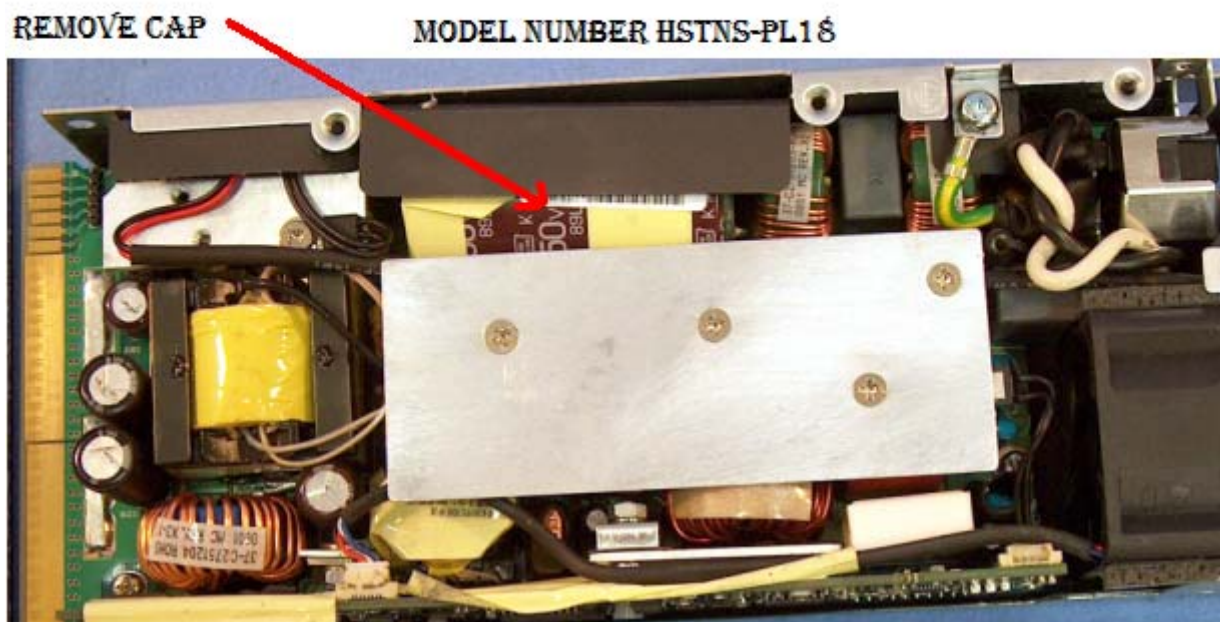
**REMOVE THIS CAP** **MODEL NUMBER HSTNS-PL14**



Attachment 2



Attachment 3

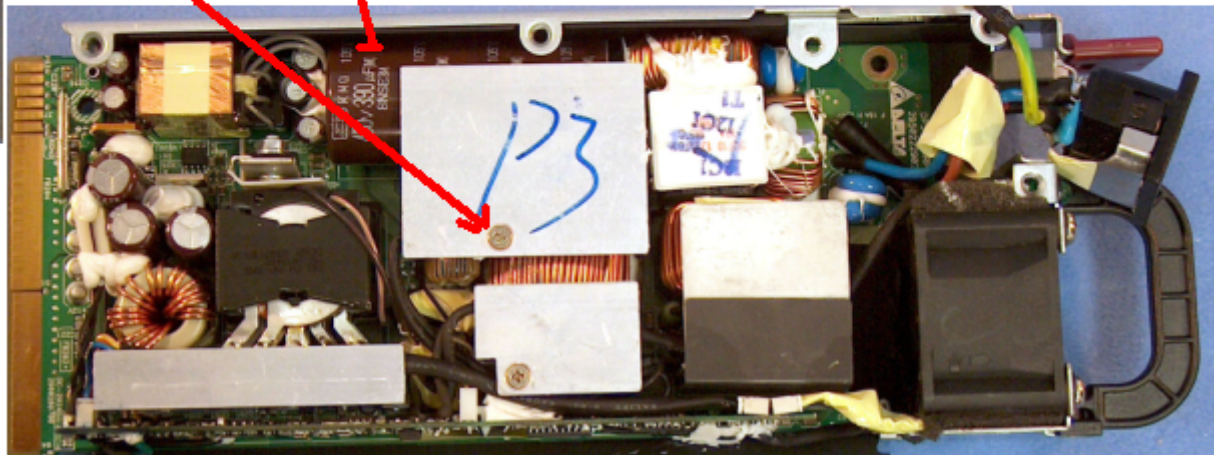


Attachment 4



REMOVE SCREW THEN CAP

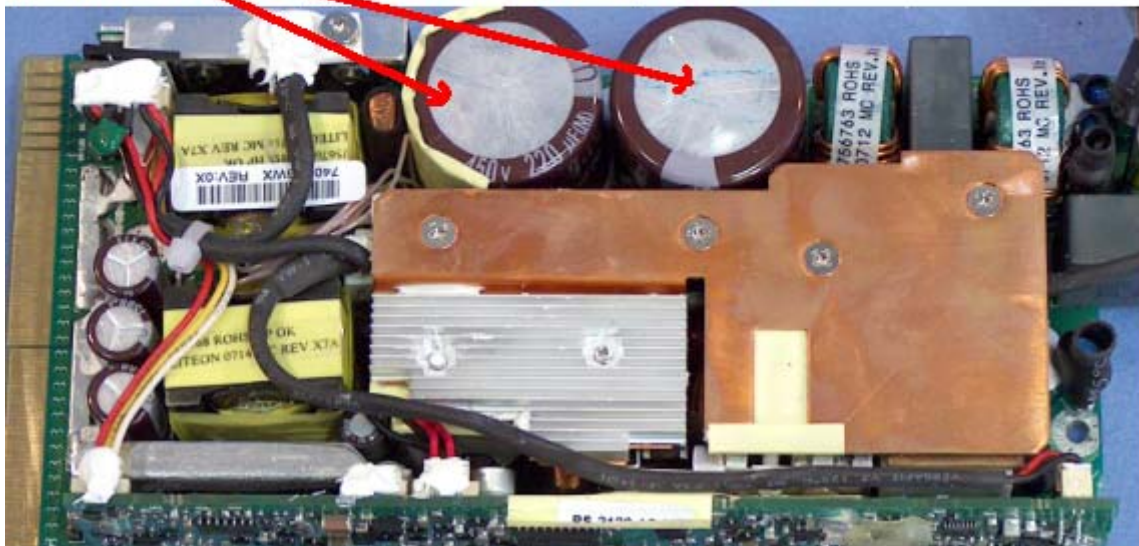
MODEL NUMBER HSTNS-PD18



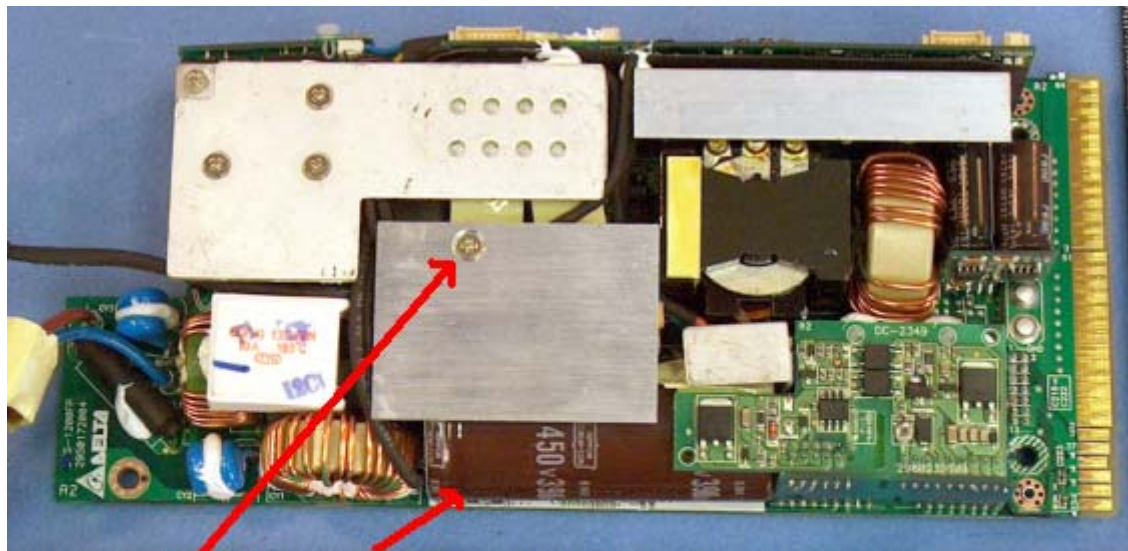
Attachment 5

REMOVE CAPS

MODEL NUMBER HSTNS PL11



Attachment 6



REMOVE SCREW THEN CAP

MODEL NUMBER HSTNS-PD11

Attachment 7



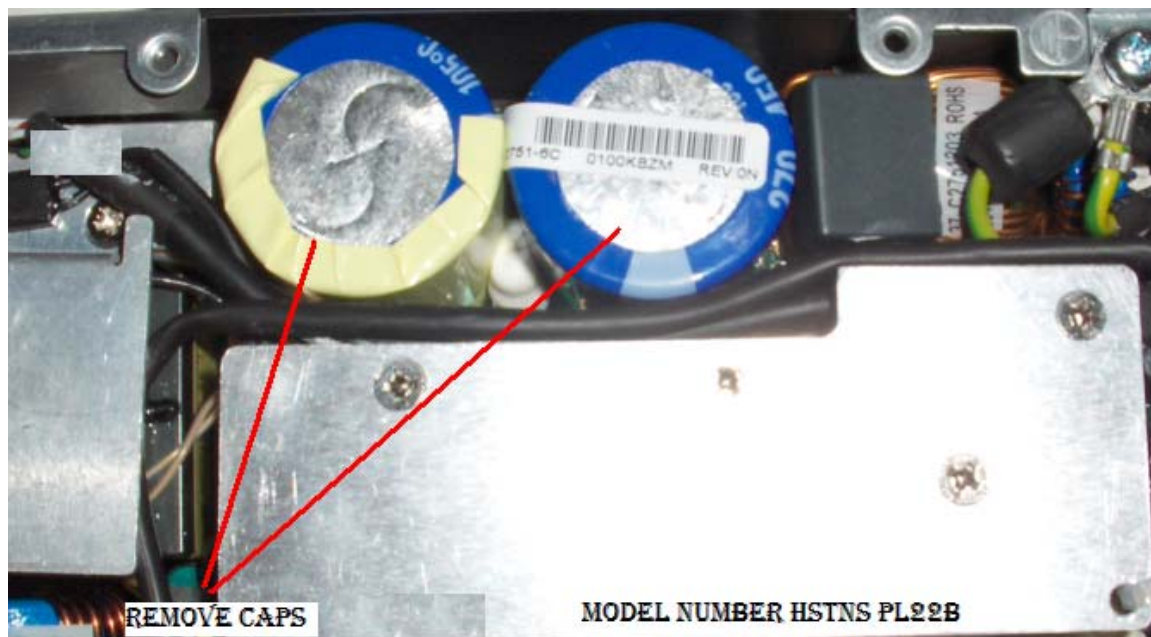
REMOVE CAP

MODEL NUMBER HSTNS-PR17

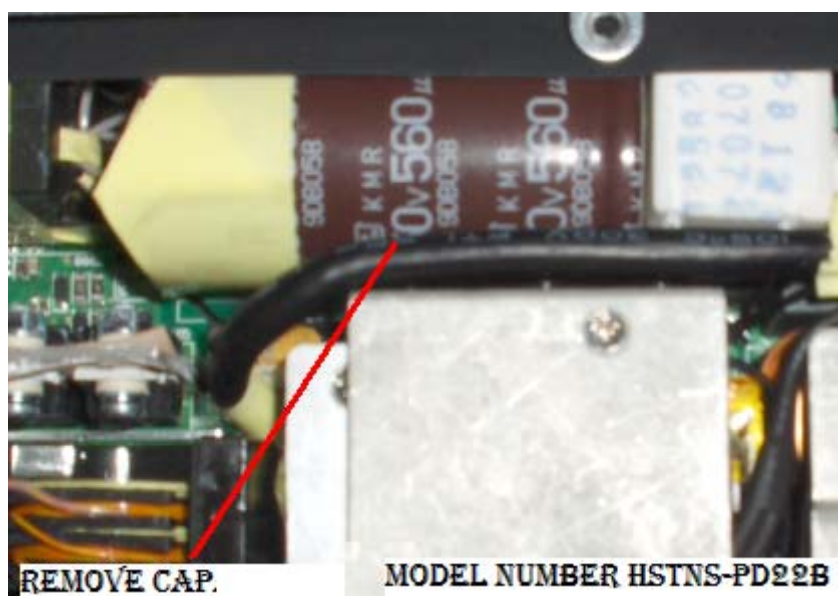
Attachment 8



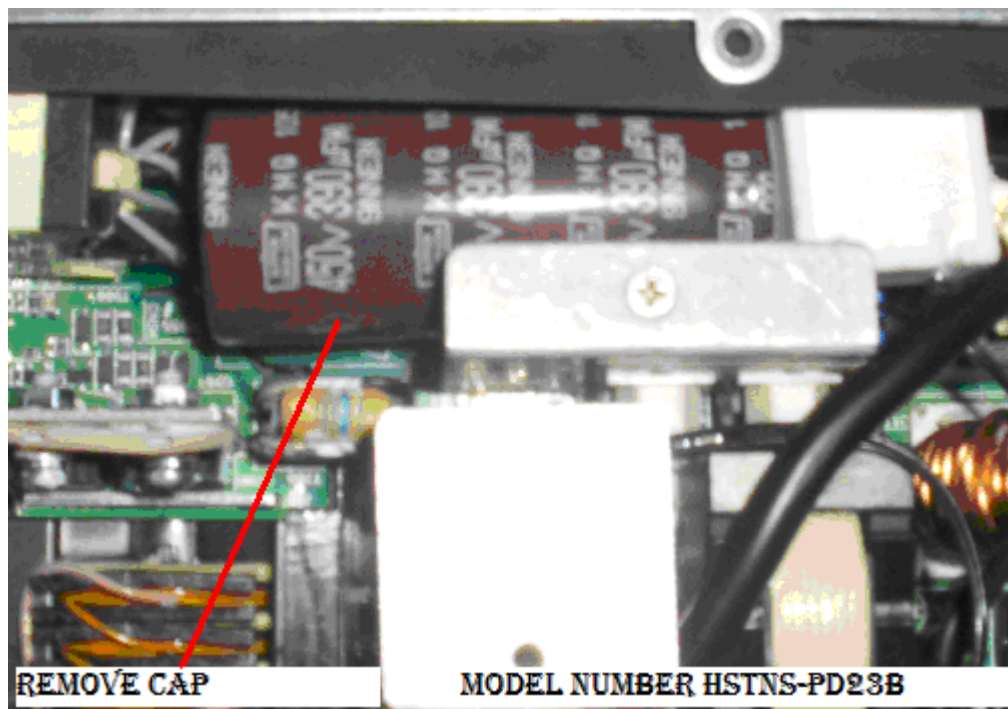




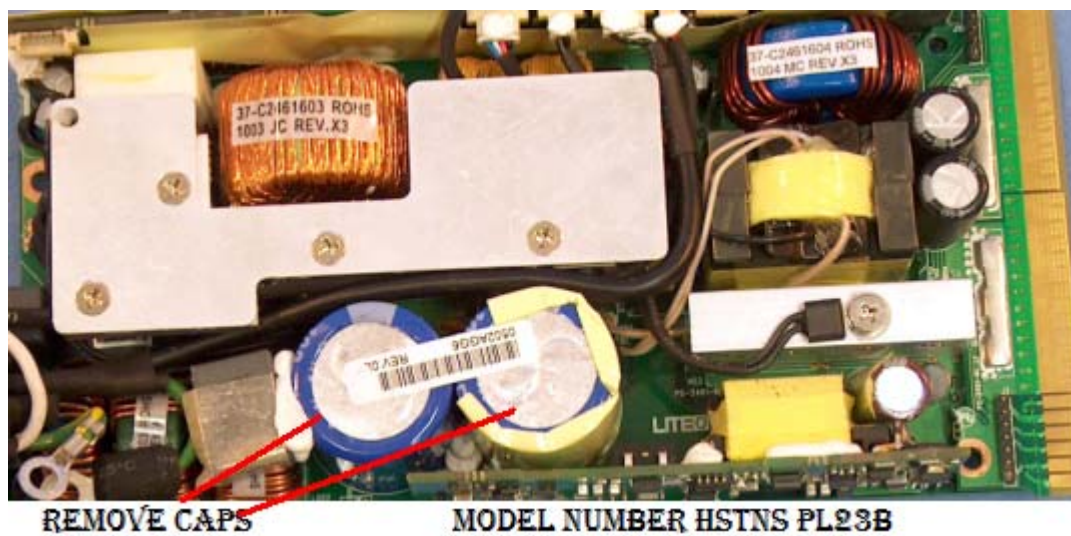
Attachment 9



Attachment 10



Attachment 11



Attachment 12